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Renesas Technology Corp.
Customer Support Dept.
April 1, 2003

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Keep safety first in your circuit designs!

1. Renesas Technology Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage.

Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

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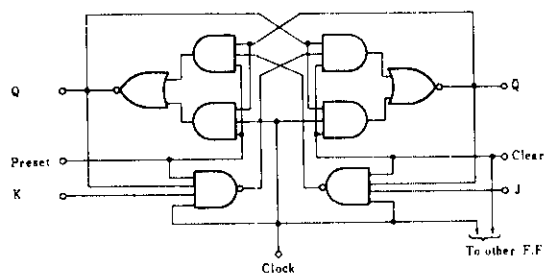
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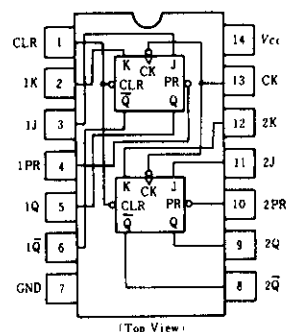
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HD74LS114 • Dual J-K Negative-edge-triggered Flip-Flops (with Preset, Common Clear and Common Clock)

■ BLOCK DIAGRAM (1/2)



■ PIN ARRANGEMENT



■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Clock frequency	f_{clock}	0	—	30	MHz
Pulse width	Clock High	20	—	—	ns
	Preset Clear Low	25	—	—	ns
Setup time	"H" Data	20↓	—	—	ns
	"L" Data	20↓	—	—	ns
Hold time	t_h	0↓	—	—	ns

Note) ↓; The arrow indicates the falling edge.

■ FUNCTION TABLE

Inputs					Outputs	
Preset	Clear	Clock	J	K	Q	$\bar{Q}$
L	H	X	X	X	H	L
H	L	X	X	X	L	H
L	L	X	X	X	H*	H*
H	H	↓	L	L	Q_0	$\bar{Q}_0$
H	H	↓	H	L	H	L
H	H	↓	L	H	L	H
H	H	↓	H	H	Toggle	
H	H	H	X	X	Q_0	$\bar{Q}_0$

Notes) H; high level, L; low level, X; irrelevant

↓; transition from high to low level

Q_0 ; level of Q before the indicated steady-state input conditions were established.

$\bar{Q}_0$; complement of Q_0 or level of $\bar{Q}$ before the indicated steady-state input conditions were established.

Toggle; each output changes to the complement of its previous level on each active transition indicated by ↓.

*; This configuration is nonstable; that is, it will not persist when preset and clear inputs return to their inactive (high) level.

HD74LS114

■ ELECTRICAL CHARACTERISTICS ($T_a = -20 \sim +75^\circ\text{C}$)

Item		Symbol	Test Conditions	min	typ*	max	Unit
Input voltage		V_{IH}		2.0	—	—	V
		V_{IL}		—	—	0.8	V
Output voltage		V_{OH}	$V_{CC} = 4.75\text{V}$, $V_{IH} = 2\text{V}$, $V_{IL} = 0.8\text{V}$, $I_{OH} = -400\mu\text{A}$	2.7	—	—	V
		V_{OL}	$V_{CC} = 4.75\text{V}$, $V_{IL} = 0.8\text{V}$, $I_{OL} = 8\text{mA}$	—	—	0.5	V
			$V_{IH} = 2\text{V}$, $I_{OL} = 4\text{mA}$	—	—	0.4	
				—	—	—	
Input current	J, K	I_{IH}	$V_{CC} = 5.25\text{V}$, $V_I = 2.7\text{V}$	—	—	20	μA
	Clear			—	—	120	
	Preset			—	—	60	
	Clock			—	—	160	
	J, K	I_{IL}^{**}	$V_{CC} = 5.25\text{V}$, $V_I = 0.4\text{V}$	—	—	-0.4	mA
	Clear			—	—	-1.6	
	Preset			—	—	-0.8	
	Clock			—	—	-1.6	
	J, K	I_I	$V_{CC} = 5.25\text{V}$, $V_I = 7\text{V}$	—	—	0.1	mA
	Clear			—	—	0.6	
	Preset			—	—	0.3	
	Clock			—	—	0.8	
Short-circuit output current		I_{OS}	$V_{CC} = 5.25\text{V}$	-20	—	-100	mA
Supply current ***		I_{CC}	$V_{CC} = 5.25\text{V}$	—	4	8	mA
Input clamp voltage		V_{IK}	$V_{CC} = 4.75\text{V}$, $I_{IS} = -18\text{mA}$	—	—	-1.5	V

* $V_{CC} = 5\text{V}$, $T_a = 25^\circ\text{C}$

** I_{IL} should not be measured when preset and clear inputs are low at same time.

*** With all outputs open, I_{CC} is measured with the Q and $\bar{Q}$ output high in turn. At the time of measurement, the clock input is grounded.

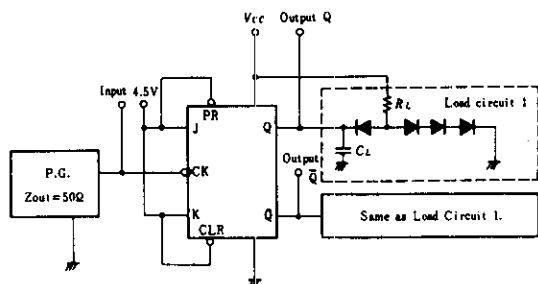
■ SWITCHING CHARACTERISTICS ($V_{CC} = 5\text{V}$, $T_a = 25^\circ\text{C}$)

Item	Symbol	Inputs	Outputs	Test Conditions	min	typ	max	Unit
Maximum clock frequency	f_{max}			$C_L = 15\text{pF}, R_L = 2\text{k}\Omega$	30	45	—	MHz
Propagation delay time	t_{PLH}	Clear Preset Clock	Q, $\bar{Q}$		—	11	20	ns
	t_{PHL}				—	15	30	ns

■ TESTING METHOD

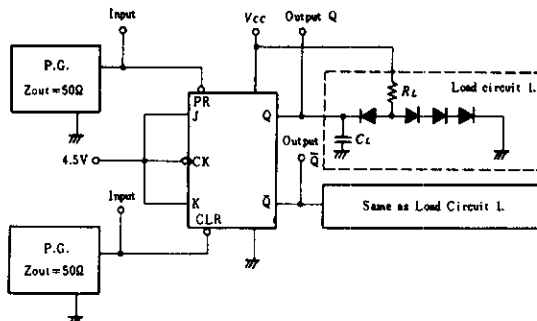
1) Test Circuit

1.1) f_{max} , t_{PLH} , t_{PHL} (Clock $\rightarrow$ Q, $\bar{Q}$)



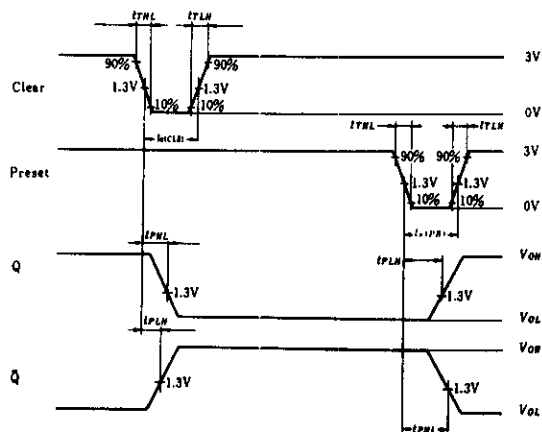
- Notes) 1. Test is put into the each flip-flop.
2. All diodes are 1S2074 (B).
3. C_L includes probe and jig capacitance.

1.2) t_{PHL} , t_{PLH} (Clear, Preset $\rightarrow$ Q, $\bar{Q}$)



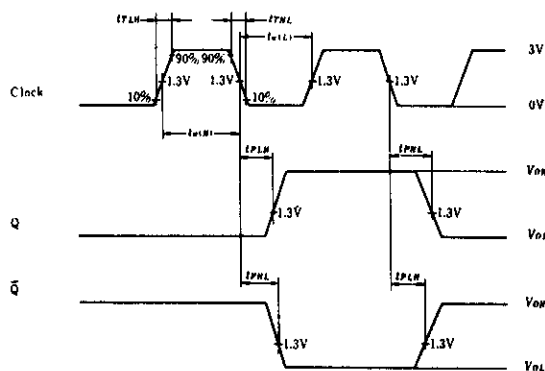
- Notes) 1. Test is put into the each flip-flop.
2. All diodes are 1S2074 (B).
3. C_L includes probe and jig capacitance.

Waveform

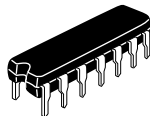
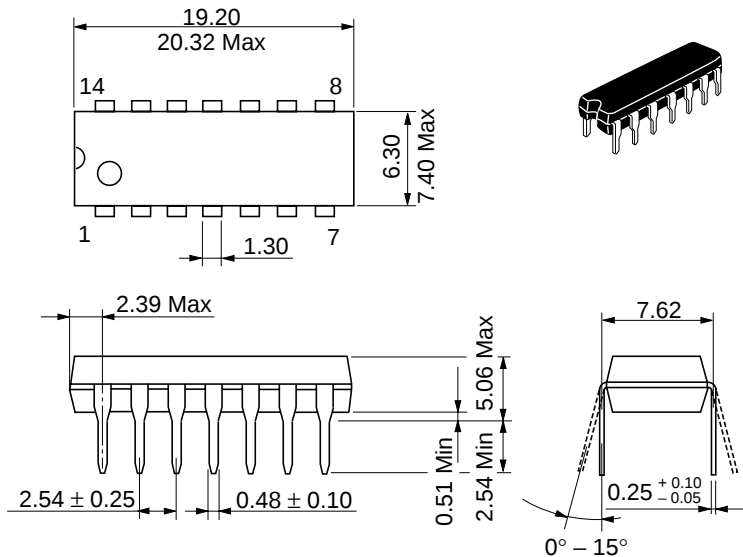


Note) Clock input pulse: $t_{TLH} \leq 15\text{ns}$, $t_{THL} \leq 6\text{ns}$, $PRR=1\text{MHz}$, duty cycle=50% and: for f_{max} , $t_{TLH}=t_{THL} \leq 2.5\text{ns}$.

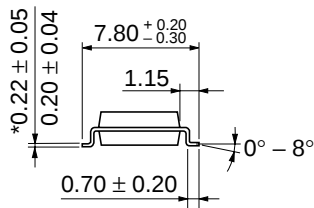
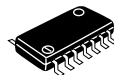
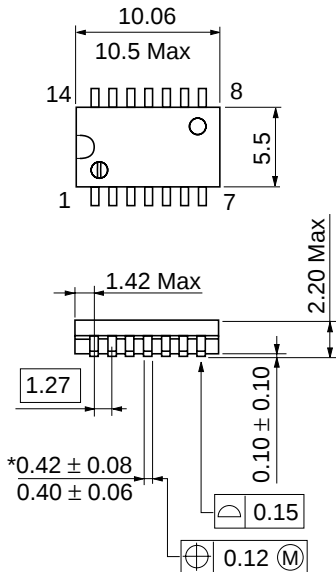
Waveform



Note) Clear and preset input pulse: $t_{TLH} \leq 15\text{ns}$, $t_{THL} \leq 6\text{ns}$, $PRR=1\text{MHz}$

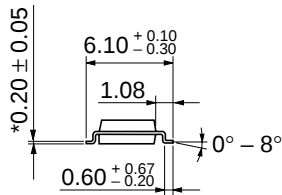
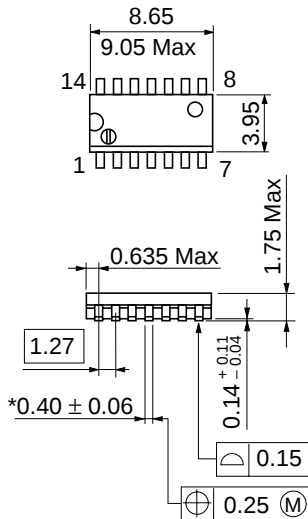


Hitachi Code	DP-14
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.97 g



Hitachi Code	FP-14DA
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.23 g

*Dimension including the plating thickness
Base material dimension



Hitachi Code	FP-14DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.13 g

*Pd plating

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